



Product/Process Change Notice - PCN 12_0256 Rev. -

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

This notice is to inform you of a change that will be made to certain ADI products (see Material Report). Any issues with this PCN or requirements to qualify the change (additional data or samples) must be sent to ADI within 30 days of publication date. ADI contact information is listed below.

PCN Title: AD6624A Fab transfer from TSMC Fab 5 to Fab 3
Publication Date: 10-Dec-2012
Effectivity Date: 17-Dec-2012 *(the earliest date that a customer could expect to receive changed material)*

Revision Description:

Initial Release

Description Of Change

Move from shut down wafer Fab 5 to wafer Fab 3C on identical process .25 Cmos process

Reason For Change

Consumption of last time buy material from Fab 5

Impact of the change (positive or negative) on fit, form, function & reliability

None

Product Identification *(this section will describe how to identify the changed material)*

Date code 1253

Summary of Supporting Information

No qualification activity required due to use of same mask set. The AD6624 will undergo parametric test evaluation prior to release per the existing test specifications as defined in the data sheet.

Supporting Documents None

For questions on this PCN, send email to the regional contacts below or contact your local ADI sales representative

Americas: PCN_Americas@analog.com	Europe: PCN_Europe@analog.com	Japan: PCN_Japan@analog.com
		Rest of Asia: PCN_ROA@analog.com

Appendix A - Affected ADI Models

Added Parts On This Revision - Product Family / Model Number (1)

AD6624A / AD6624AABCZ				
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Appendix B - Revision History

Rev	Publish Date	Effectivity Date	Rev Description
Rev. -	10-Dec-2012	17-Dec-2012	Initial Release

Analog Devices, Inc.

DocId:2133 Parent DocId:None Layout Rev:7